

SEMICONDUCTOR TM

FDP4020P/FDB4020P

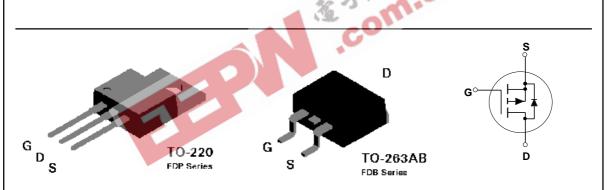
P-Channel 2.5V Specified Enhancement Mode Field Effect Transistor

General Description

This P-Channel low threshold MOSFET has been designed for use as a linear pass element for low voltage outputs. In addition, the part may be used as a low voltage load switch when switching outputs on or off for power management. The part may also be used in conjunction with DC-DC converters requiring P-Channel.

Features

- -16 A, -20 V. $R_{DS(on)} = 0.08 \ \Omega @ V_{GS} = -4.5 \ V R_{DS(on)} = 0.11 \ \Omega @ V_{GS} = -2.5 \ V.$
- Critical DC electrical parameters specified at elevated temperature.
- High density cell design for extremely low R_{DS(on)}
- TO-220 and TO-263 (D²PAK) package for both through hole and surface mount applications.
- 175°C maximum junction temperature rating.



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	FDP4020P	FDB4020P	Units
V _{DSS}	Drain-Source Voltage	-20		V
V _{GSS}	Gate-Source Voltage	±8		V
I _D	Drain Current - Continuous	-16		А
	- Pulsed	-48		
P _D	Total Power Dissipation @ T _c = 25°C	37.5		W
	Derate above 25∘C	0.25		W/∘C
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-65 to +175		°C
Therma	I Characteristics			
R _θ JC	Thermal Resistance, Junction-to- Case	4		∘C/W
R _{θJA}	Thermal Resistance, Junction-to- Ambient (Note 1)	62.5	40	∘C/W

Package Outlines and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDP4020P	FDP4020P	13"	12mm	2500 units
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February 1999

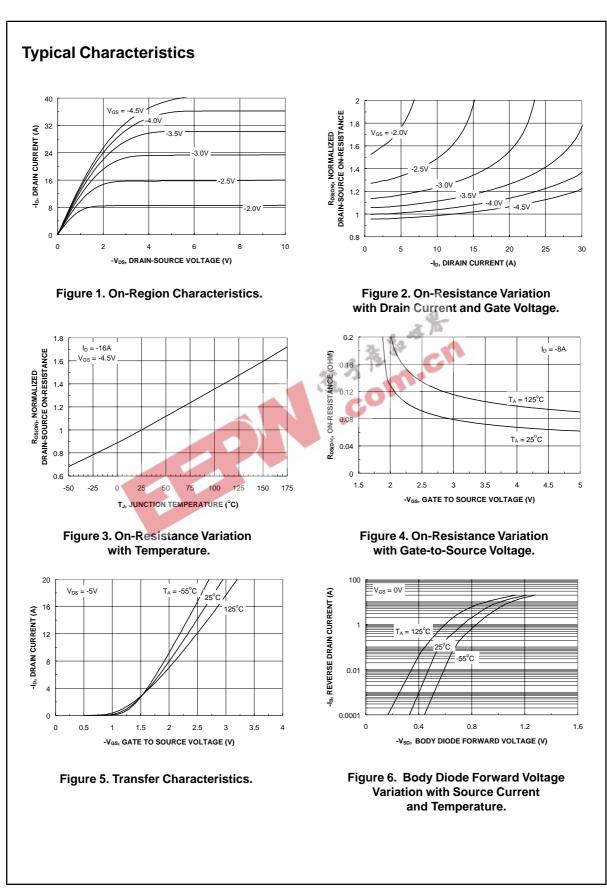
PRELIMINARY

Symbol	Parameter	Test Conditions	Min	Turn	Mox	Units
Symbol	Parameter	Test Conditions		Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0~V,~I_{D}=-250~\mu A$	-20			V
<u>A</u> BV⊡ss ∆Tj	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-28		mV/∘C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -8 V, V_{DS} = 0 V			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-0.58	-1	V
<u>A</u> VGS(th) ΔT.I	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 _{\text{L}}\text{A}$, Referenced to 25°C		2		mV/∘C
R _{DS(on)}	Static Drain-Source On-Resistance		- A-	0.068 0.098 0.096	0.08 0.13 0.110	Ω
I _{D(on)}	On-State Drain Current	V _{GS} = -4.5 V, V _{DS} = -5 V	-20			A
g _{FS}	Forward Transconductance	$V_{DS} = -5 V, I_D = -8 A$	-	14		S
Dynamic	Characteristics	CO.				
C _{iss}	Input Capacitance	$V_{DS} = -10 V, V_{GS} = 0 V,$		665		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		270		pF
C _{rss}	Reverse Transfer Capacitance			70		pF
Switchin	g Characteristics (Note 2)			1	1	<u> </u>
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -5 V, I_D = -1 A,$		8	16	ns
t _r	Turn-On Rise Time	V_{GS} = -4.5 V, R_{GEN} = 6 Ω		24	38	ns
t _{d(off)}	Turn-Off Delay Time			50	80	ns
t _f	Turn-Off Fall Time			29	45	ns
Qg	Total Gate Charge	V _{DS} = -5 V,		9.5	13	nC
Q _{gs}	Gate-Source Charge	$I_{D} = -16 \text{ A}, V_{GS} = -4.5 \text{ V}$		1.3		nC
Q _{gd}	Gate-Drain Charge			2.2		nC
Drain-So	urce Diode Characteristics	and Maximum Ratings				•
l _s	Source Diode Characteristics and Maximum Ratings Maximum Continuous Drain-Source Diode Forward Current (Note 2)				-16	Α
-					-48	
I _{SM}	I Maximum Pulseo Dialo-Source D					

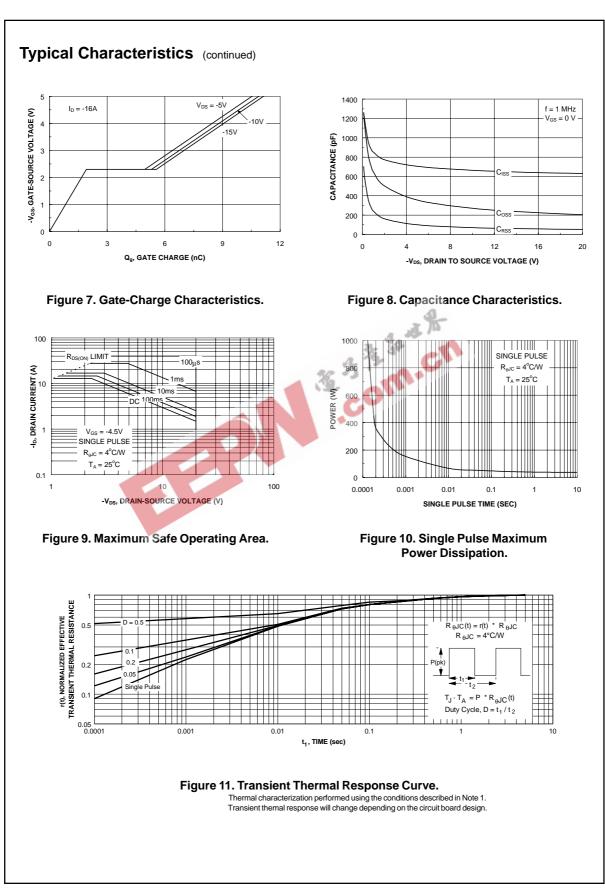
Notes:

1. R_{0JA} is the sum of the juntion-to-case and case-to-ambient thermal resistance. For T0-263 the device is mounted on circuit board with a 1in² pad of 2 oz. copper. **2.** Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%

FDP4020P

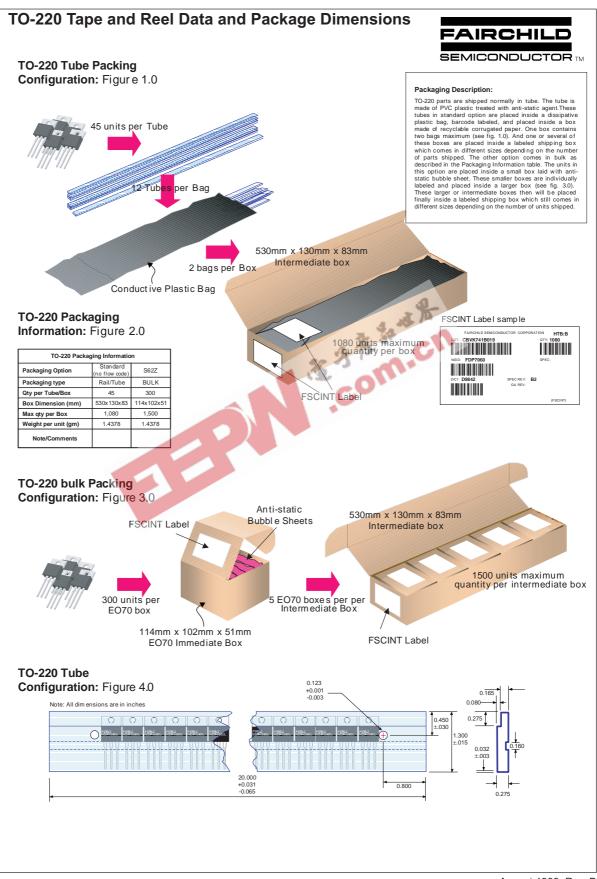


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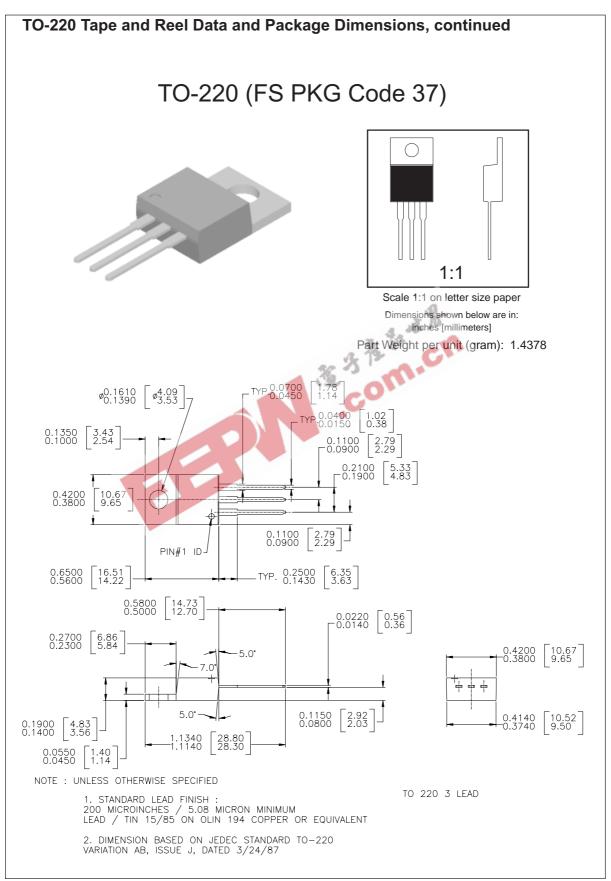


FDP4020P

FDP4020P Rev. A



August 1999, Rev. B



September 1998, Rev. A

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